

SECTION 096519 - RESILIENT FLOOR TILE

PART 1 - GENERAL

1.1 SUMMARY

- A. Section Includes:
 - 1. Vinyl composition floor tile (VCT).
 - 2. Static dissipative vinyl composition floor tile.

1.2 ACTION SUBMITTALS

- A. General: Submit in accordance with Section 013000.
- B. See Section 013310 for Submittal Schedule.

1.3 CLOSEOUT SUBMITTALS

- A. Maintenance data.

1.4 QUALITY ASSURANCE

- A. Fire-Test-Response Characteristics: As determined by testing identical products according to ASTM E648 or NFPA 253 by a qualified testing agency.
 - 1. Critical Radiant Flux Classification: Class I, not less than 0.45 W/sq. cm.
 - 2. ASTM E 662 (Smoke Generation) Maximum Specific Optical Density of 450 or less.

1.5 PROJECT CONDITIONS

- A. Maintain ambient temperatures within range recommended by manufacturer in spaces to receive floor tile.
- B. Until Substantial Completion, maintain ambient temperatures within range recommended by manufacturer.
- C. Close spaces to traffic during floor tile installation.
- D. Close spaces to traffic for 48 hours after floor tile installation.
- E. Install floor tile after other finishing operations, including painting, have been completed.

PART 2 - PRODUCTS

2.1 PERFORMANCE REQUIREMENTS

- A. FloorScore Compliance: Resilient tile flooring shall comply with requirements of FloorScore Standard.
- B. Low-Emitting Materials: Flooring system shall comply with the testing and product requirements of the California Department of Health Services' "Standard Practice for the Testing of Volatile Organic Emissions from Various Sources Using Small-Scale Environmental Chambers."

2.2 VINYL COMPOSITION FLOOR TILE

- A. **Basis-of-Design Product:** Subject to compliance with requirements, provide **Armstrong World Industries, Inc.; Standard Excelon, Imperial Texture** or comparable product by one of the following:
 - 1. [Congoleum Corporation.](#)
 - 2. [Mannington Mills, Inc.](#)
 - 3. [Tarkett, Inc.](#)
 - 4. Approved equal.
- B. **Tile Standard:** ASTM F1066, Class 2, through-pattern tile.
- C. **Wearing Surface:** Smooth.
- D. **Thickness:** 0.125 inch.
- E. **Size:** 12 by 12 inches.
- F. **Colors and Patterns:** As noted on drawings.

2.3 STATIC DISSIPATIVE VINYL COMPOSITION FLOOR TILE

- A. **Basis-of-Design Product:** Subject to compliance with requirements, provide **Armstrong World Industries, Inc.; Static Dissipative Tile** or comparable product by one of the following:
 - 1. [Congoleum Corporation.](#)
 - 2. [Mannington Mills, Inc.](#)
 - 3. [Tarkett, Inc.](#)
 - 4. Approved equal.
- B. **Tile Standard:** ASTM F1066, Class 2, through-pattern tile.
- C. **Wearing Surface:** Smooth.
- D. **Thickness:** 0.125 inch.
- E. **Size:** 12 by 12 inches.
- F. **Colors and Patterns:** As noted on drawings.

2.4 INSTALLATION MATERIALS

- A. **Trowelable Leveling and Patching Compounds:** Latex-modified, portland cement based or blended hydraulic-cement-based formulation provided or approved by manufacturer for applications indicated.
- B. **Adhesives:**
 - 1. **Standard VC T:** Water-resistant type recommended by manufacturer to suit floor tile and substrate conditions indicated.
 - 2. **Static Dissipative VCT:** Armstrong S-202 Static Dissipative Tile Adhesive with 2 in. wide x 24 in. long copper ground-connection strips under the tile and Armstrong S-725 Wall Base Adhesive at the wall base as recommended by the flooring manufacturer.
 - 3. Adhesives shall comply with the following limits for VOC content:
 - a. Vinyl Composition Tile Adhesives: 50 g/L or less.
- C. **Floor Polish:** Provide protective liquid floor polish products as recommended by manufacturer.

PART 3 - EXECUTION

3.1 PREPARATION

- A. Prepare substrates according to manufacturer's written instructions to ensure adhesion of resilient products.
- B. Concrete Substrates: Prepare according to ASTM F710.
 - 1. Verify that substrates are dry and free of curing compounds, sealers, and hardeners.
 - 2. Remove substrate coatings and other substances that are incompatible with adhesives and that contain soap, wax, oil, or silicone, using mechanical methods recommended by manufacturer. Do not use solvents.
 - 3. Alkalinity and Adhesion Testing: Perform tests recommended by manufacturer. Proceed with installation only after substrates pass testing.
 - 4. Moisture Testing: Perform tests recommended by floor covering manufacturer. Proceed with installation only after substrates pass testing.
 - a. Perform anhydrous calcium chloride test, ASTM F1869. Proceed with installation only after substrates have maximum moisture-vapor-emission rate of 3 lb of water/1000 sq. ft. in 24 hours.
 - b. Perform relative humidity test using in situ probes, ASTM F2170. Proceed with installation only after substrates have a maximum 75% relative humidity level measurement.
- C. Fill cracks, holes, and depressions in substrates with trowelable leveling and patching compound and remove bumps and ridges to produce a uniform and smooth substrate.
- D. Do not install floor tiles until they are same temperature as space where they are to be installed.
 - 1. Move resilient products and installation materials into spaces where they will be installed at least 48 hours in advance of installation.
- E. Sweep and vacuum clean substrates to be covered by resilient products immediately before installation.

3.2 FLOOR TILE INSTALLATION

- A. Comply with manufacturer's written instructions for installing floor tile.
- B. Lay out floor tiles from center marks established with principal walls, discounting minor offsets, so tiles at opposite edges of room are of equal width. Adjust as necessary to avoid using cut widths that equal less than one-half tile at perimeter.
 - 1. Lay tiles square with room axis.
- C. Match floor tiles for color and pattern by selecting tiles from cartons in the same sequence as manufactured and packaged, if so numbered. Discard broken, cracked, chipped, or deformed tiles.
 - 1. Lay tiles with grain direction alternating in adjacent tiles (basket-weave pattern).
- D. Scribe, cut, and fit floor tiles to butt neatly and tightly to vertical surfaces and permanent fixtures including built-in furniture, cabinets, pipes, outlets, and door frames.
- E. Extend floor tiles into toe spaces, door reveals, closets, and similar openings. Extend floor tiles to center of door openings.

- F. Maintain reference markers, holes, and openings that are in place or marked for future cutting by repeating on floor tiles as marked on substrates. Use chalk or other nonpermanent, nonstaining marking device.
- G. Adhere floor tiles to flooring substrates using a full spread of adhesive applied to substrate to produce a completed installation without open cracks, voids, raising and puckering at joints, telegraphing of adhesive spreader marks, and other surface imperfections.

3.3 CLEANING AND PROTECTION

- A. Comply with manufacturer's written instructions for cleaning and protection of floor tile.
- B. Floor Polish: Remove soil, visible adhesive, and surface blemishes from floor tile surfaces before applying liquid floor polish.
 - 1. Apply three coat(s).

END OF SECTION 096519